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Precision Low-voltage Amplifier

Features

- Low Offset:
 - $-10 \mu V Max.$
- □ Low Drift:
 - $-0.05 \,\mu\text{V/°C Max}$.
- □ Low Noise:
 - 17 nV/√Hz
- □ Open-loop Voltage Gain:
 - 150 dB Typ.
- □ Rail-to-Rail Inputs
- □ Rail-to-Rail Output Swing
 - to within 10 mV of supply voltage
- 1.0 mA Supply Current
- □ Slew rate:
 - 0.25 V/μs

Applications

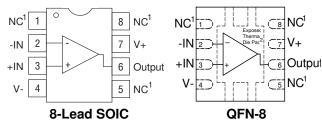
- ☐ Thermocouple/Thermopile Amplifiers
- □ Load Cell and Bridge Transducer Amplifiers
- □ Precision Instrumentation
- Battery-powered Systems

Description

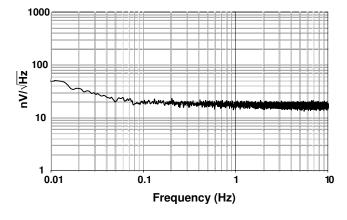
The CS3003 single amplifier is designed for precision amplification of low-level signals. This amplifier achieves excellent offset stability, high open loop gain, and low noise. The devices also exhibit excellent CMRR and PSRR. The common mode input range includes the supply rails. The amplifier operates with any supply voltage from 2.7 V to 5 V (± 1.35 V to ± 2.50 V).

Pin Configurations

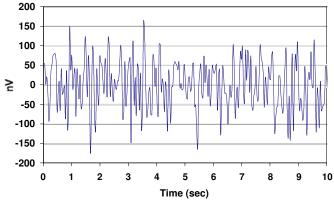




- 1. Must not be connected.
- 2. Connect thermal die pad to V-.



Noise vs. Frequency (Measured)



0.01 Hz to 10 Hz Noise Performance

Advance Product Information

This document contains information for a new product. Cirrus Logic reserves the right to modify this product without notice.



	OF CONTENTS1. CHARACTERISTICS AND SPECIFICATIONS 5 V Electrical Characteristics	
1.2 3	3 V Electrical Characteristics	4
1.3 A	Absolute Maximum Ratings	5
	CAL PERFORMANCE PLOTS	
	KAGE DRAWINGS	
	ERING INFORMATION	
	RONMENTAL, MANUFACTURING, & HANDLING INFORMATION	
	SION HISTORY	
LIST OF FI		
Figure 1.	Noise vs Frequency (Measured)	5
Figure 2.	0.01 Hz to 10 Hz Noise	5
Figure 3.	Gain & Phase vs. Frequency (2.7 V)	
Figure 4.	Gain & Phase vs. Frequency (5 V)	
Figure 5.	Supply Current vs. Supply Voltage	
Figure 6.	Supply Current vs. Temperature	
Figure 7.	Voltage Swing vs. Output Current (2.7 V)	
Figure 8.	Voltage Swing vs. Output Current (5 V)	6

Contacting Cirrus Logic Support

For all product questions and inquiries contact a Cirrus Logic Sales Representative. To find one nearest you go to http://www.cirrus.com

IMPORTANT NOTICE

"Advance" product information describes products that are in design or in limited production, but for which full characterization data is not yet available.

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1. CHARACTERISTICS AND SPECIFICATIONS

1.1 5 V Electrical Characteristics

 $V+=+5~V,\pm5\%; V-=0V; VCM=2.5~V; Unless otherwise noted, T_A=25^{\circ}~C$ (See Note 1).

Parameter		Min	Тур	Max	Unit
Input Offset Voltage (Note 2)	•	-	±2	±10	μV
Average Input Offset Drift (Note 2)	•	-	±0.01	±0.05	μV/ºC
Input Bias Current		-	±170	±250	pА
	•	-	-	±1.5	nA
Input Offset Current		-	±340	±500	pΑ
	•	-	-	±3.0	nA
Input Noise Voltage Density $R_S = 100 \Omega$, $f_0 = 1 Hz$		-	17	-	nV/\sqrt{Hz}
$R_S = 100 \Omega, f_0 = 1 \text{ kHz}$		-	17	-	nV/√Hz
Input Noise Voltage 0.1 to 10 Hz		-	350	-	nV _{p-p}
Input Noise Current Density $f_0 = 1 \text{ Hz}$		-	100	-	fA/√Hz
Input Noise Current 0.1 to 10 Hz		-	1.9		pA _{p-p}
Input Voltage Range (Note 2)	•	V-	-	V+	V
Common Mode Rejection Ratio (dc)	•	110	120	-	dB
Power Supply Rejection Ratio	•	110	130	-	dB
Large Signal Voltage Gain		-	150	-	dB
(Note 3) $R_L = 2 k\Omega$ to V+/2		120	150	-	dB
Output Voltage Swing $R_L = 2 k\Omega$ to V+/2	•	(V+ - 100)	-	(V- + 100)	mV
(Note 4) $R_L = 100 \text{ k}\Omega$ to V+/2		(V+ - 10)	-	(V- + 10)	mV
Slew Rate $R_L = 2 \text{ k}, 100 \text{ pF}$			0.25	-	V/µs
Overload Recovery Time		-	25	-	μs
Supply Current	•	-	1.0	TBD	mA
Chopping Frequency		-	150	-	kHz
Input Capacitance Differential		-	1.5	-	pF
Common Mode		-	10	-	pF

Notes: 1. Symbol " \bullet " denotes specification applies over -40 to +125 $^{\circ}$ C.

- 2. This parameter is guaranteed by design and/or laboratory characterization.
- 3. Guaranteed within the output limits of $(V+-0.2\ V)$ to $(V-+0.2\ V)$.
- 4. Specifies the worst case drive voltage relative to the supply rail under stated load conditions.



1.2 3 V Electrical Characteristics

V+ = +3 V, $\pm 10\%$; V- = 0V; VCM = 2.5 V; Unless otherwise noted, T_A = 25 $^{\circ}$ C (See Note 5).

Parameter		Min	Тур	Max	Unit
Input Offset Voltage (Note 6)	•	-	±2	±10	μV
Average Input Offset Drift (Note 6)	•	-	±0.01	±0.05	μV/ºC
Input Bias Current		-	±110	±150	рА
	•	-	-	±1.0	nA
Input Offset Current		-	±220	±300	pΑ
	•	-	-	±2.0	nA
Input Noise Voltage Density $R_S = 100 \Omega$, $f_0 = 1 Hz$		-	17	-	nV/√Hz
$R_S = 100 \Omega, f_0 = 1 \text{ kHz}$		-	17	-	nV/√Hz
Input Noise Voltage 0.1 to 10 Hz		-	350	-	nV _{p-p}
Input Noise Current Density $f_0 = 1 \text{ Hz}$		-	100	-	fA/\sqrt{Hz}
Input Noise Current 0.1 to 10 Hz		-	1.9		pA _{p-p}
Input Voltage Range (Note 6)	•	V-	-	V+	V
Common Mode Rejection Ratio (DC)	•	110	120	-	dB
Power Supply Rejection Ratio	•	110	130	-	dB
Large Signal Voltage Gain		-	160	-	dB
(Note 7) $R_L = 2 k\Omega \text{ to } V+/2$	•	120	150	-	dB
Output Voltage Swing $R_L = 2 k\Omega$ to V+/2	•	(V+ - 100)	-	(V- + 100)	mV
(Note 8) $R_L = 100 \text{ k}\Omega$ to V+/2		(V+ - 10)	-	(V- + 10)	mV
Slew Rate $R_L = 2 \text{ k}, 100 \text{ pF}$			0.25	-	V/µs
Overload Recovery Time		-	25	-	μs
Supply Current	•	-	2.0	2.5	mA
Chopping Frequency		-	150	-	kHz
Input Capacitance Differential		-	1.5	-	pF
Common Mode		-	10	-	pF

Notes: 5. Symbol " \bullet " denotes specification applies over -40 to +125 $^{\circ}$ C.

- 6. This parameter is guaranteed by design and/or laboratory characterization.
- 7. Guaranteed within the output limits of $(V+-0.2\ V)$ to $(V-+0.2\ V)$.
- 8. Specifies the worst case drive voltage relative to the supply rail under stated load conditions.



1.3 Absolute Maximum Ratings

Paran	eter	Min	Тур	Max	Unit
Supply Voltage [(V+) -	(V-)]	2.7	-	5.5	V
Input Voltage		(V-) - 0.3	-	(V+) + 0.3	V
Storage Temperature Range		-65	-	+150	ōC

2. TYPICAL PERFORMANCE PLOTS

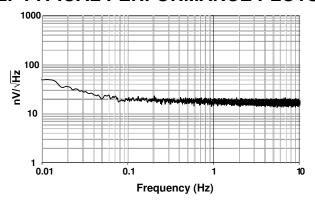


Figure 1. Noise vs Frequency (Measured)

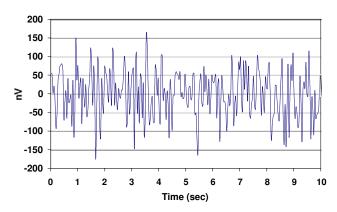


Figure 2. 0.01 Hz to 10 Hz Noise

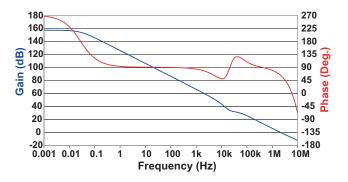


Figure 3. Gain & Phase vs. Frequency (2.7 V)

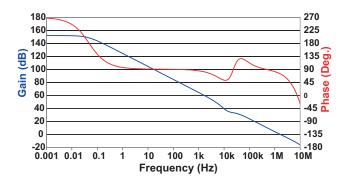


Figure 4. Gain & Phase vs. Frequency (5 V)

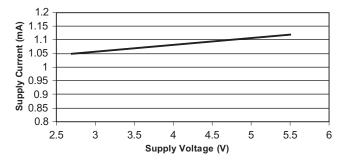


Figure 5. Supply Current vs. Supply Voltage

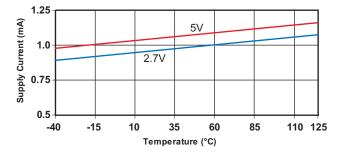
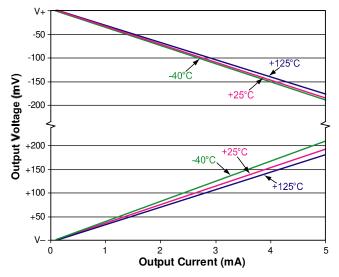


Figure 6. Supply Current vs. Temperature



Typical Performance Plots (Cont.)



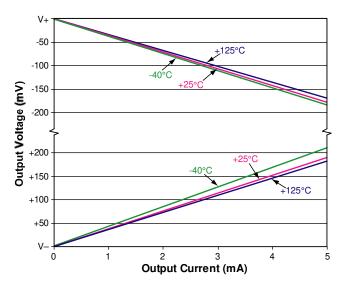
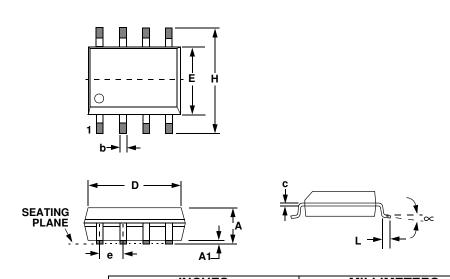


Figure 7. Voltage Swing vs. Output Current (2.7 V)

Figure 8. Voltage Swing vs. Output Current (5 V)

3. PACKAGE DRAWINGS

8L SOIC (150 MIL BODY) PACKAGE DRAWING

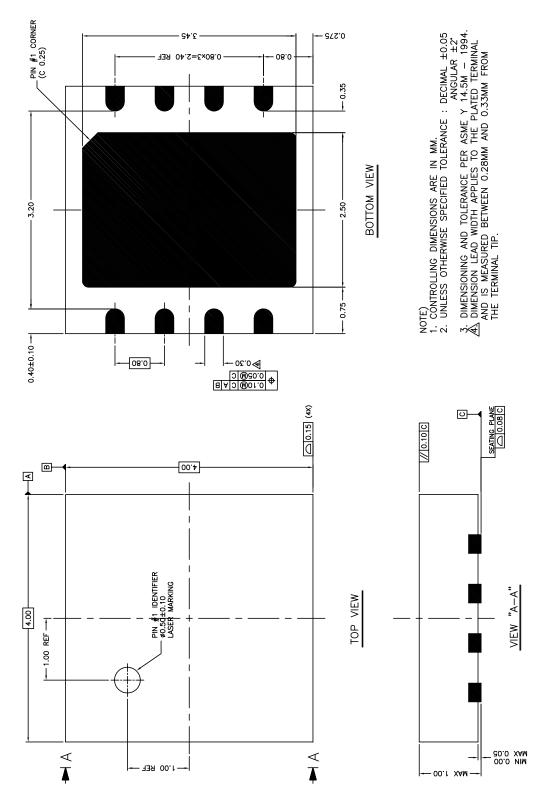


	INC	HES	MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
В	0.013	0.020	0.33	0.51
С	0.007	0.010	0.19	0.25
D	0.189	0.197	4.80	5.00
E	0.150	0.157	3.80	4.00
е	0.040	0.060	1.02	1.52
H	0.228	0.244	5.80	6.20
L	0.016	0.050	0.40	1.27
∞	0°	8°	0°	8°

JEDEC #: MS-012



8L QFN (4 mm X 4 mm) PACKAGE DRAWING





4. ORDERING INFORMATION

Part #	Temperature Range	Package Description
CS3003-FS	-40 °C to +125 °C	8-lead SOIC
CS3003-FSZ	-40 °C to +125 °C	8-lead SOIC, Lead Free
CS3003-FNZ*	-40 °C to +125 °C	8-lead QFN, Lead Free

^{*} Connect thermal die pad to V-.

5. ENVIRONMENTAL, MANUFACTURING, & HANDLING INFORMATION

Model Number	Peak Reflow Temp	MSL Rating*	Max Floor Life
CS3003-FS	240 °C		
CS3003-FSZ	260 °C	2	365 Days
CS3003-FNZ	200 C		

^{*} MSL (Moisture Sensitivity Level) as specified by IPC/JEDEC J-STD-020.

6. REVISION HISTORY

Revision	Date	Changes
A0	JAN 2007	Initial Release.